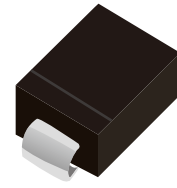


FEATURES

- | Low profile package
- | Ideal for automated placement
- | Glass passivated Junction chip
- | High forward surge current capability
- | Meet AEC-Q101 Requirements



DO-214AA(SMB)



Schematic Symbol

APPLICATIONS

- | For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer and telecommunication

APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003

MAXIMUM RATINGS AND CHARACTERISTICS (T_A=25°C)

Parameter		Symbol	GS2A BQ	GS2B BQ	GS2D BQ	GS2G BQ	GS2J BQ	GS2K BQ	GS2M BQ	Unit
Marking			GS2A	GS2B	GS2D	GS2G	GS2J	GS2K	GS2M	
Maximum Repetitive Peak Reverse Voltage		V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage		V _{RMS}	35	70	140	280	420	560	700	
Maximum DC Blocking Voltage		V _{DC}	50	100	200	400	600	800	1000	
Average Rectified Output Current @60Hz Sine Wave, Resistance Load, TL (Fig.1)		I _O	2							A
Forward Surge Current (Non-Repetitive) @60Hz Half-Sine Wave,1 Cycle, Tj=25°C		I _{FSM}	50							
Maximum Instantaneous Forward Voltage I _{FM} =2.0A		V _F	1.15				V			
Maximum DC reverse current at rated DC blocking voltage per diode @ V _{RM} =V _{RRM}	T _a =25°C	I _R	5.0				μA			
	T _a =125°C		100							
Typical junction capacitance V _R =4V,f=1 MHz		C _J	18				pF			
Typical Thermal Resistance ⁽¹⁾		R _{θJ-A}	75 ¹⁾				°C/W			
		R _{θJ-L}	20 ¹⁾							
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55 ~ +150							°C

Note:

(1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.27" x 0.27" (7.0 mm x 7.0 mm) copper pad areas

CHARACTERISTIC CURVES

Fig. 1- I_o - T_L Curve

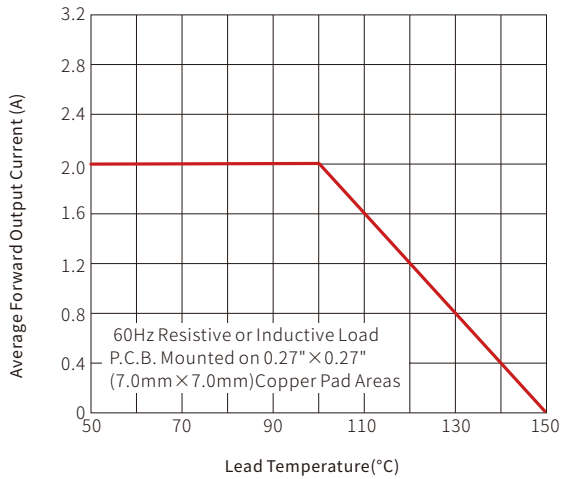


Fig. 2-Surge Forward Current Capability

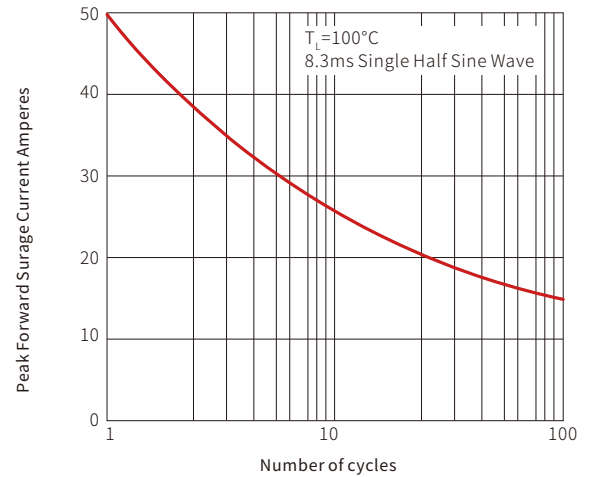


Fig. 3-Typical Instantaneous Forward Characteristics

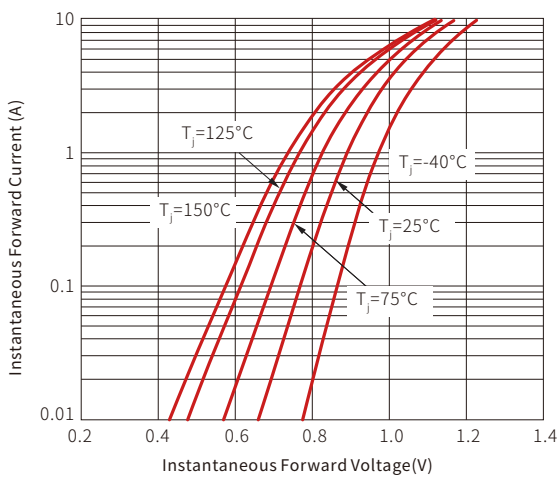
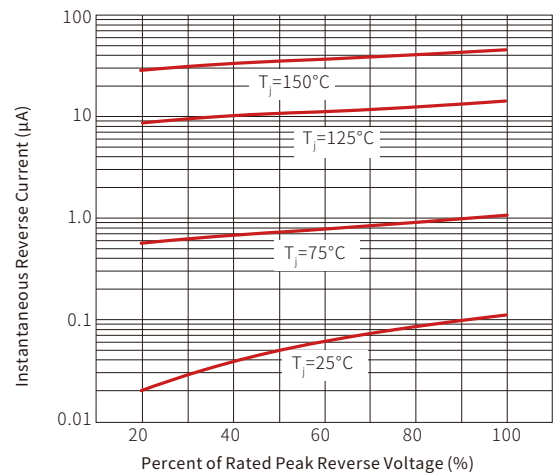
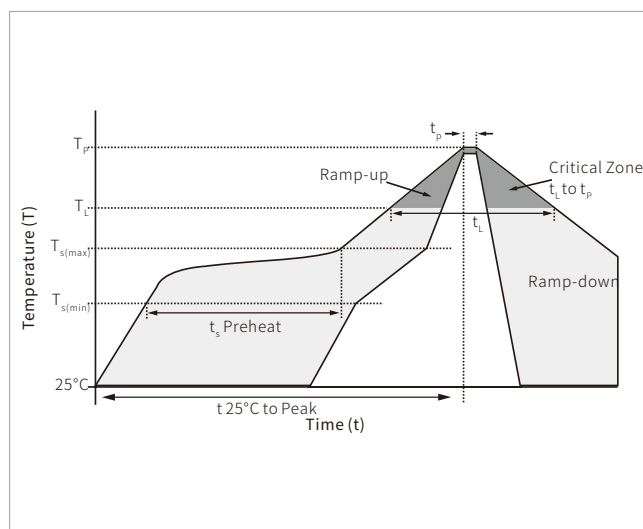


Fig. 4-Typical Reverse Characteristics

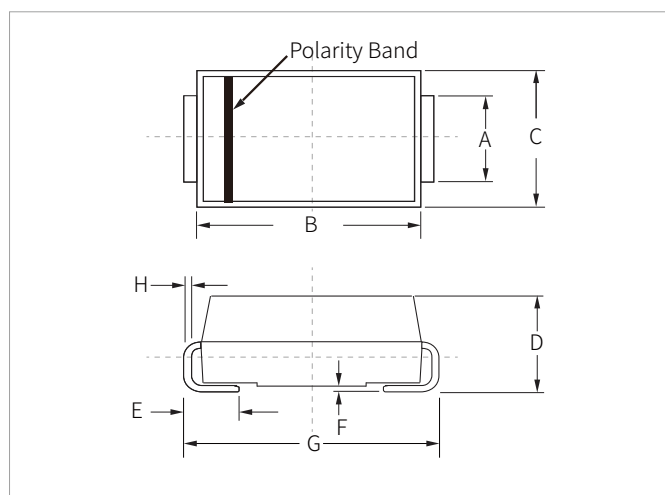


SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly
Pre Heat	Temperature Max ($T_{s(min)}$)	150°C
	Temperature Max ($T_{s(max)}$)	200°C
	Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	Temperature (T_L) (Liquidus)	217°C
	Time (min to max) (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260°C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes max.
Do not exceed		260°C

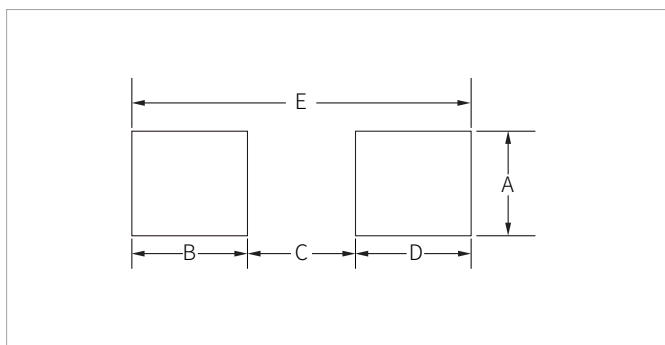


DO-214AA(SMB) PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	1.80	2.20	0.071	0.087
B	4.30	4.70	0.170	0.185
C	3.40	3.90	0.134	0.153
D	2.15	2.75	0.085	0.108
E	1.00	1.50	0.039	0.059
F	0.02	0.20	0.001	0.008
G	5.10	5.50	0.200	0.216
H	0.15	0.30	0.006	0.012

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.20	-	0.087	-
B	1.45	-	0.057	-
C	-	2.55	-	0.010
D	1.45	-	0.057	-
E	5.60REF		0.220REF	

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
GS2ABQ-GS2MBQ	DO-214AA(SMB)	3000PCS	13"

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By QR Code

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